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IGBT

SGH15N60RUF

Short Circuit Rated IGBT

General Description

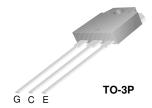
Fairchild's RUF series of Insulated Gate Bipolar Transistors (IGBTs) provide low conduction and switching losses as well as short circuit ruggedness. The RUF series is designed for applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short circuit ruggedness is a required feature.

Features

- Short circuit rated 10us @ $T_C = 100$ °C, $V_{GE} = 15V$
- · High speed switching
- Low saturation voltage : $V_{CE(sat)} = 2.2 \text{ V}$ @ $I_C = 15 \text{A}$
- · High input impedance

Applications

AC & DC motor controls, general purpose inverters, robotics, and servo controls.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		SGH15N60RUF	Units
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
	Collector Current	@ T _C = 25°C	24	Α
I _C	Collector Current	@ T _C = 100°C	15	Α
I _{CM (1)}	Pulsed Collector Current		45	Α
	Short Circuit Withstand Time	@ T _C = 100°C	10	us
T _{SC} P _D	Maximum Power Dissipation	@ T _C = 25°C	160	W
	Maximum Power Dissipation	@ T _C = 100°C	64	W
T _J	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

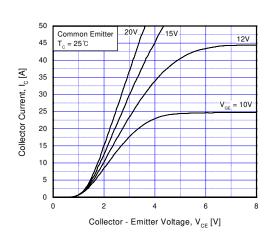
Notes

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.77	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W	

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250uA	600			V
ΔB _{VCES} / ΔΤ _J	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0V, I _C = 1mA		0.6		V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Chai	racteristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 15$ mA, $V_{CE} = V_{GE}$	5.0	6.0	8.5	V
	Collector to Emitter	I _C = 15A, V _{GE} = 15V		2.2	2.8	V
V _{CE(sat)}	Saturation Voltage	$I_C = 24A$, $V_{GE} = 15V$		2.5		V
Dynami	c Characteristics		1	1	1	
C _{ies}	Input Capacitance	V 20V V 0V		948		pF
C _{oes}	Output Capacitance	$V_{CE} = 30V_{,} V_{GE} = 0V_{,}$ f = 1MHz		101		pF
C _{res}	Reverse Transfer Capacitance	- 1 = 11VITIZ		33		pF
t _{d(on)}	ng Characteristics Turn-On Delay Time			17		ns
t _r	Rise Time			33		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 15\text{A},$		44	65	ns
t _f	Fall Time	$R_G = 13\Omega, V_{GE} = 15V,$		118	200	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C		320		uJ
E _{off}	Turn-Off Switching Loss			356		uJ
E _{ts}	Total Switching Loss			676	950	uJ
t _{d(on)}	Turn-On Delay Time			20		ns
t _r	Rise Time			34		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 15\text{A},$		48	70	ns
t _f	Fall Time	$R_G = 13\Omega, V_{GE} = 15V,$		212	350	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 125°C		340		uJ
E _{off}	Turn-Off Switching Loss	1		695		uJ
E _{ts}	Total Switching Loss	1		1035	1450	uJ
T _{sc}	Short Circuit Withstand Time	V _{CC} = 300 V, V _{GE} = 15V @ T _C = 100°C	10			us
Q _g	Total Gate Charge	-		42	60	nC
Q _{qe}	Gate-Emitter Charge	$V_{CE} = 300 \text{ V}, I_{C} = 15\text{A},$		7	10	nC
Q _{gc}	Gate-Collector Charge	V _{GE} = 15V		17	24	nC
L _e	Internal Emitter Inductance	Measured 5mm from PKG		14		nH



10 5 0 10 10

Common Emitter

V_{GE} = 15V T_C = 25℃

40

35

30

25

20

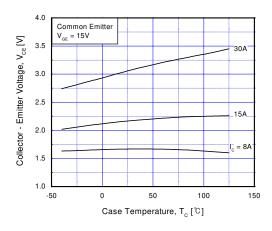
15

Collector Current, I_c [A]

Fig 1. Typical Output Characteristics

Fig 2. Typical Saturation Voltage Characteristics

Collector - Emitter Voltage, $V_{CE}[V]$



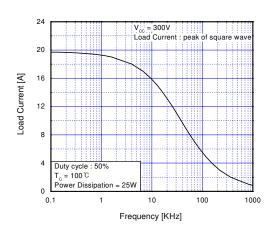
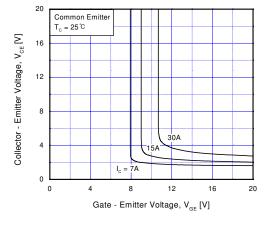


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

Fig 4. Load Current vs. Frequency



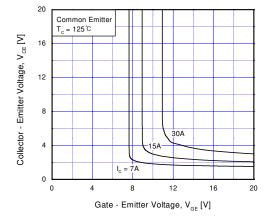


Fig 5. Saturation Voltage vs. V_{GE}

Fig 6. Saturation Voltage vs. V_{GE}

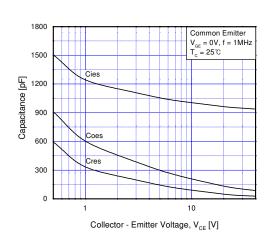


Fig 7. Capacitance Characteristics

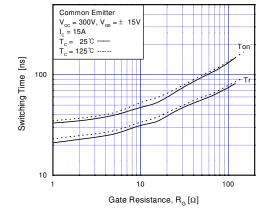


Fig 8. Turn-On Characteristics vs.
Gate Resistance

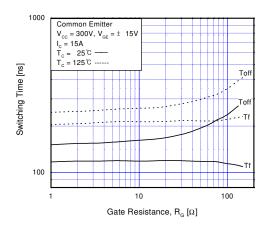


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

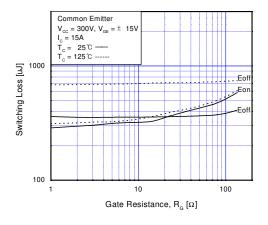


Fig 10. Switching Loss vs. Gate Resistance

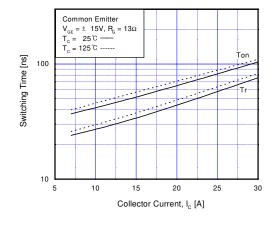


Fig 11. Turn-On Characteristics vs. Collector Current

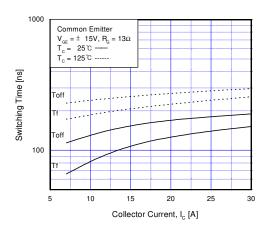
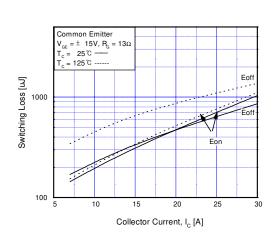


Fig 12. Turn-Off Characteristics vs. Collector Current



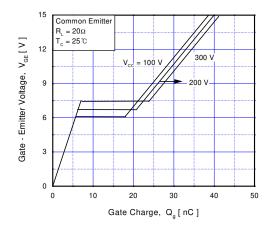
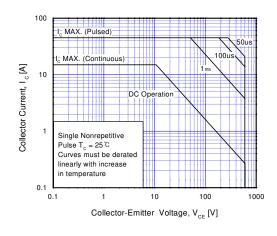


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



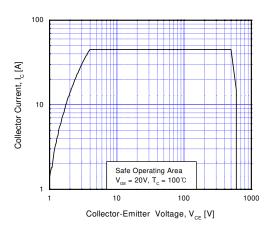


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

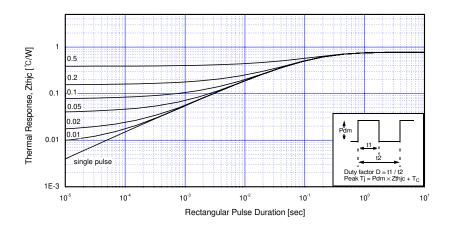
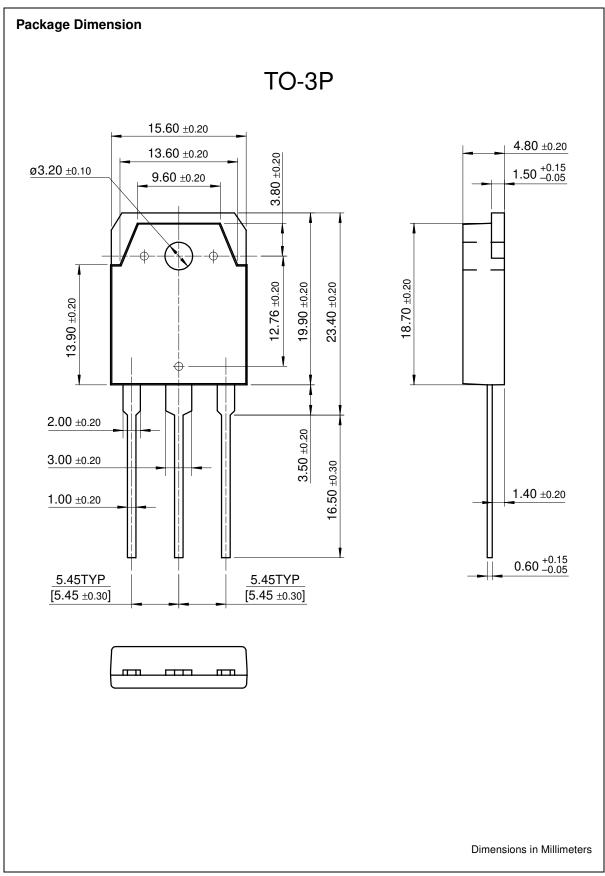


Fig 17. Transient Thermal Impedance of IGBT



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